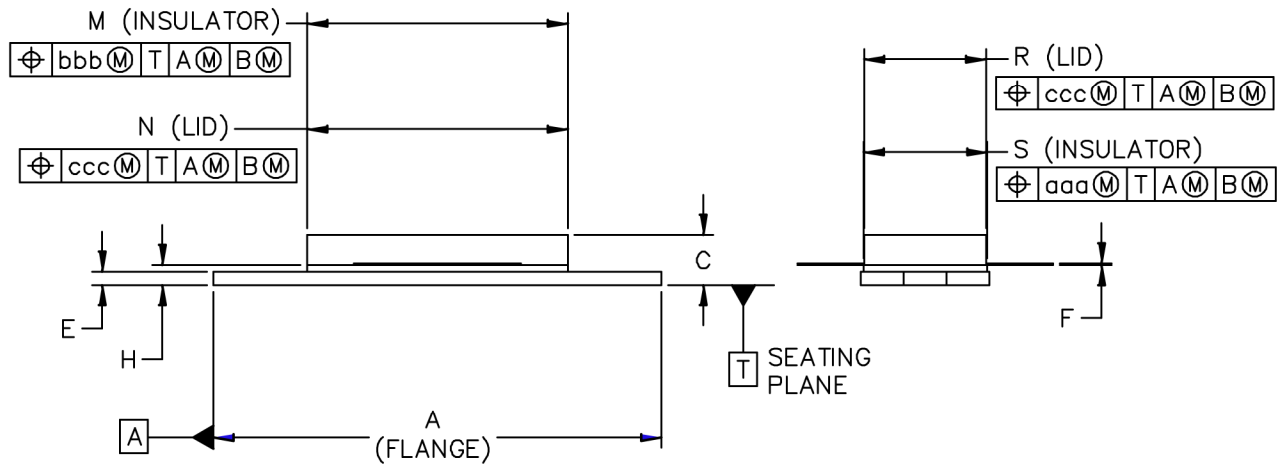
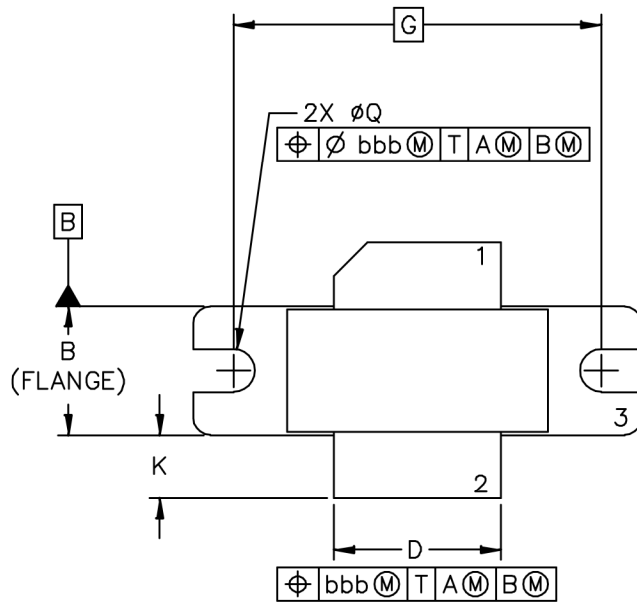


## PACKAGE DIMENSIONS



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	CASE NUMBER: 465-06		31 MAR 2005
	STANDARD: NON-JEDEC		

MRF8S9100HR3 MRF8S9100HSR3

NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M–1994.
2. CONTROLLING DIMENSION: INCH.
3. DELETED
4. DIMENSION H IS MEASURED .030 (.762) AWAY FROM PACKAGE BODY.

STYLE 1:

- PIN 1. DRAIN  
2. GATE  
3. SOURCE

INCH		MILLIMETER		INCH		MILLIMETER	
DIM	MIN	MAX	MIN	MAX	DIM	MIN	MAX
A	1.335	— 1.345	33.91	— 34.16	R	.365	— .375
B	.380	— .390	9.65	— 9.91	S	.365	— .375
C	.125	— .170	3.18	— 4.32	aaa	— .005	—
D	.495	— .505	12.57	— 12.83	bbb	— .010	—
E	.035	— .045	0.89	— 1.14	ccc	— .015	—
F	.003	— .006	0.08	— 0.15	—	—	—
G	1.100 BSC		27.94 BSC		—	—	—
H	.057	— .067	1.45	— 1.7	—	—	—
K	.170	— .210	4.32	— 5.33	—	—	—
M	.774	— .786	19.66	— 19.96	—	—	—
N	.772	— .788	19.6	— 20	—	—	—
Q	ø.118	— ø.138	ø3	— ø3.51	—	—	—
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